



## DESCRIPTION

The **highly efficient** Automated SCSe is the ideal solution for submicron cleaning of Photomasks, Wafers and Substrates in a cassette to cassette format. The robot transfer station can accommodate up to three cleaning modules. The **very reliable** and **cost effective** cleaning modules utilizes **proven** assortment of cleaning technologies. The SCSe can be configured with several different cleaning options form High Pressure DI, Atomizing Mist Nozzle, Brushes, Megasonic Pies and Nozzles, and much more. The Rapid and Effective Drying technique combines Variable Spin Speeds optional Heated DI, Nitrogen Assist or Heat Lamp.

## FEATURES:

- Substrate Compatibility will depend on cleaning module selected (largest is 29" diameter).
- Main Spindle Assembly having Servo Motor
- Adjustable Arm Speed and Travel Positions.
- Radially Exhausted Chamber for Maximum Laminar Flow.
- Stand-alone Polypropylene Cabinet.
- Microprocessor Control Capable of Retaining Ten (10) Programs in Memory
- Built in Safety Interlocks.
- Push Button Lid Open/Close.
- Touch Screen Graphic User Interface (GUI) with Ease of Programming & Security Lockouts and On-Screen Error Reporting.
- Maximum Capability of Four Arms.

## OPTIONS: Up to Four Oscillating Arms

- Various sizes of vacuum and edge-grip chucks for Wafers, Photomasks, and other Substrates
- Adjustable Self Cleaning Brush Assembly
- N<sub>2</sub> Drying Assist with 0.02 µm Filtration
- Fixed or Oscillating Low Pressure Dispenses
- Surfactant or Photoresist Dispense Canisters
- Chamber Rinse and/or Chamber Exhaust Assembly
- 0.2 µm Filtration for Low Pressure Dispenses
- D.I. Water Heater and Dispenses
- Oscillating Megasonic DI Water Dispense Arm

